5-stage Johnson decade counter Rev. 8 — 18 November 2011

Product data sheet

General description 1.

The HEF4017B is a 5-stage Johnson decade counter with ten spike-free decoded active HIGH outputs (Q0 to Q9), an active LOW carry output from the most significant flip-flop (Q5-9), active HIGH and active LOW clock inputs (CP0, CP1) and an overriding asynchronous master reset input (MR).

The counter is advanced by either a LOW-to-HIGH transition at CP0 while CP1 is LOW or a HIGH-to-LOW transition at CP1 while CP0 is HIGH (see Table 3).

When cascading counters, the Q5-9 output, which is LOW while the counter is in states 5, 6, 7, 8, and 9, can be used to drive the CP0 input of the next counter. A HIGH on MR resets the counter to zero ($Q0 = \overline{Q5}-9 = HIGH$; Q1 to Q9 = LOW) independent of the clock inputs (CP0, CP1).

Automatic counter code correction is provided by an internal circuit: following any illegal code the counter returns to a proper counting mode within 11 clock pulses.

Schmitt trigger action makes the clock inputs highly tolerant of slower rise and fall times.

It operates over a recommended V_{DD} power supply range of 3 V to 15 V referenced to V_{SS} (usually ground). Unused inputs must be connected to V_{DD}, V_{SS}, or another input.

2. Features and benefits

- Automatic counter correction
- Tolerant of slow clock rise and fall times
- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from –40 °C to +125 °C
- Complies with JEDEC standard JESD 13-B

Ordering information 3.

Table 1. **Ordering information**

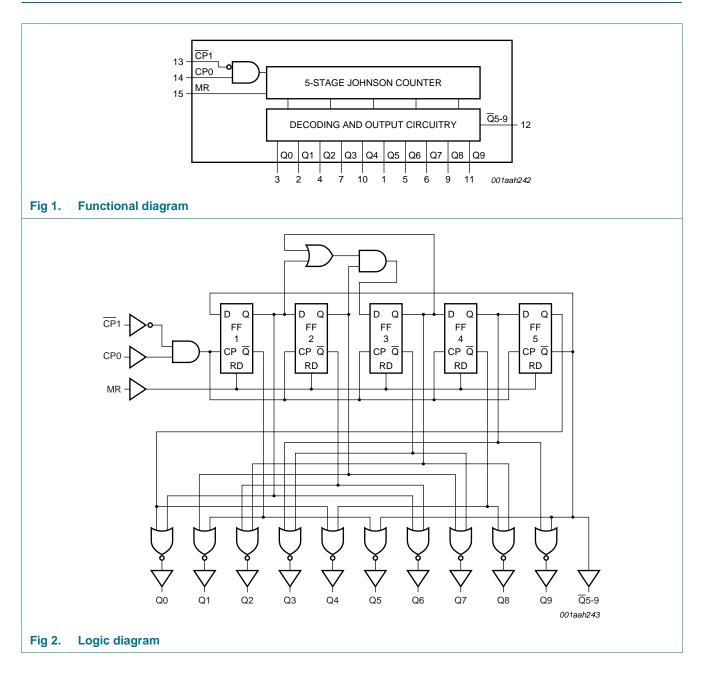
All types operate from -40 ℃ to +125 ℃

Type number	Package		
	Name	Description	Version
HEF4017BP	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4
HEF4017BT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1

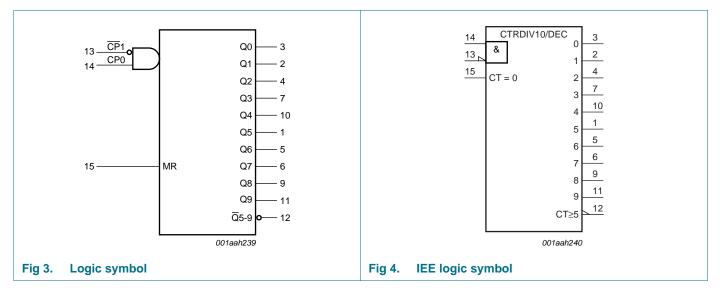


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4. Functional diagram

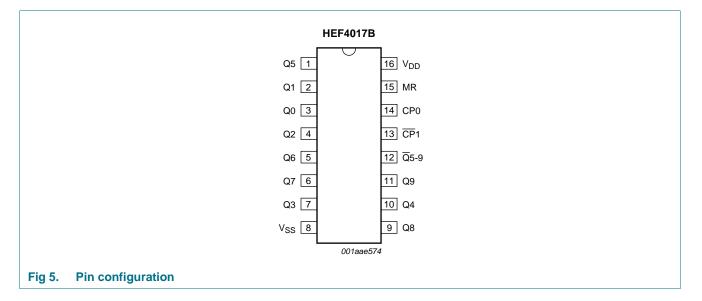


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5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
Q0 to Q9	3, 2, 4, 7, 10, 1, 5, 6, 9, 11	decoded output
V _{SS}	8	ground supply voltage
Q5-9	12	carry output (active LOW)
CP1	13	clock input (HIGH-to-LOW edge-triggered)

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Table 2.	Pin description continued	
Symbol	Pin	Description
CP0	14	clock input (LOW-to-HIGH edge-triggered)
MR	15	master reset input
V _{DD}	16	supply voltage

6. Functional description

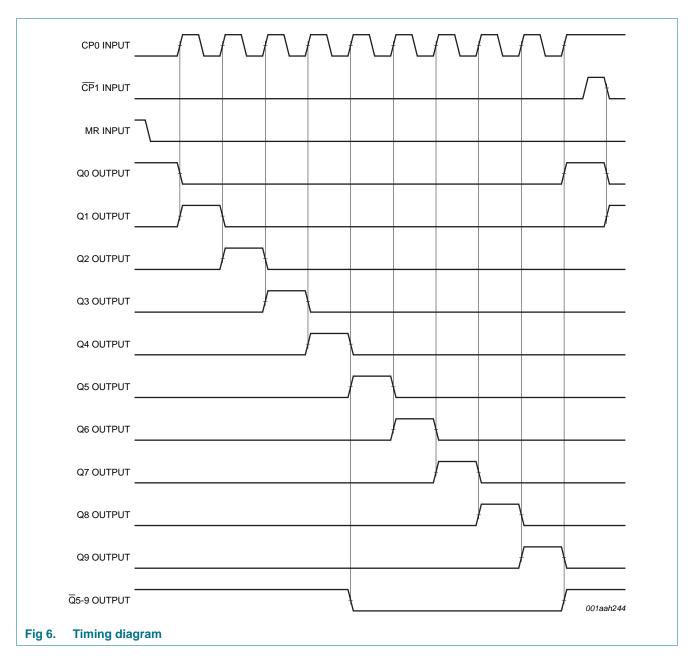
Table 3.	Function table [1]		
MR	CP0	CP1	Operation
Н	Х	Х	$Q0 = \overline{Q}5-9 = H$; Q1 to Q9 = L
L	Н	\downarrow	counter advances
L	\uparrow	L	counter advances
L	L	Х	no change
L	Х	Н	no change
L	Н	\uparrow	no change
L	\downarrow	L	no change

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care;

 \uparrow = positive-going transition; \downarrow = negative-going transition.

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Limiting values 7.

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DD}	supply voltage		-0.5	+18	V
I _{IK}	input clamping current	$V_{\rm I}$ < –0.5 V or $V_{\rm I}$ > $V_{\rm DD}$ + 0.5 V	-	±10	mA
VI	input voltage		-0.5	V _{DD} + 0.5	V
Ι _{ΟΚ}	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm DD}$ + 0.5 V	-	±10	mA
I _{I/O}	input/output current		-	±10	mA

Table 4. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

I _{DD} su	upply current				
			-	50	mA
T _{stg} ste	orage temperature		-65	+150	°C
T _{amb} ar	mbient temperature		-40	+125	°C
P _{tot} to	tal power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$			
		DIP16 package	<u>[1]</u> -	750	mW
		SO16 package	[2] _	500	mW
P pc	ower dissipation	per output	-	100	mW

[1] For DIP16 package: P_{tot} derates linearly with 12 mW/K above 70 °C.

[2] For SO16 package: P_{tot} derates linearly with 8 mW/K above 70 $^\circ C.$

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DD}	supply voltage		3	-	15	V
VI	input voltage		0	-	V_{DD}	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{DD} = 5 V$	-	-	3.75	μs/V
		V _{DD} = 10 V	-	-	0.5	μs/V
		V _{DD} = 15 V	-	-	0.08	μs/V

9. Static characteristics

Table 6.Static characteristics

 $V_{SS} = 0$ V; $V_I = V_{SS}$ or V_{DD} unless otherwise specified.

Symbol	Parameter	Conditions	ditions V _{DD}		$T_{amb} = -40 \text{ °C}$ $T_{amb} = 25 \text{ °C}$		T _{amb} =	85 °C	T _{amb} =	125 °C	Unit	
				Min	Max	Min	Max	Min	Max	Min	Max	
V _{IH}	HIGH-level	I _O < 1 μA	5 V	3.5	-	3.5	-	3.5	-	3.5	-	V
	input voltage		10 V	7.0	-	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	11.0	-	V
V _{IL}	V _{IL} LOW-level input voltage	I _O < 1 μΑ	5 V	-	1.5	-	1.5	-	1.5	-	1.5	V
			10 V	-	3.0	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	-	4.0	V
V _{OH}	HIGH-level		5 V	4.95	-	4.95	-	4.95	-	4.95	-	V
	output voltage		10 V	9.95	-	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	14.95	-	V
V _{OL}	LOW-level		5 V	-	0.05	-	0.05	-	0.05	-	0.05	V
	output voltage		10 V	-	0.05	-	0.05	-	0.05	-	0.05	V
			15 V	-	0.05	-	0.05	-	0.05	-	0.05	V

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Symbol	Parameter	Conditions	V _{DD}	T _{amb} =	–40 °C	T _{amb} =	= 25 °C	T _{amb} =	= 85 °C	T _{amb} =	125 °C	Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
I _{ОН}	HIGH-level	$V_0 = 2.5 V$	5 V	-	-1.7	-	-1.4	-	-1.1	-	-1.1	mA
	output current	$V_{O} = 4.6 V$	5 V	-	-0.64	-	-0.5	-	-0.36	-	-0.36	mA
		$V_{O} = 9.5 V$	10 V	-	-1.6	-	-1.3	-	-0.9	-	-0.9	mA
		V _O = 13.5 V	15 V	-	-4.2	-	-3.4	-	-2.4	-	-2.4	mA
OL -	LOW-level output current	$V_{O} = 0.4 V$	5 V	0.64	-	0.5	-	0.36	-	0.36	-	mA
		$V_{O} = 0.5 V$	10 V	1.6	-	1.3	-	0.9	-	0.9	-	mA
		V _O = 1.5 V	15 V	4.2	-	3.4	-	2.4	-	2.4	-	mA
I	input leakage current		15 V	-	±0.1	-	±0.1	-	±1.0	-	±1.0	μΑ
I _{DD}	supply current	I _O = 0 A;	5 V	-	5	-	5	-	150	-	150	μΑ
		$V_I = V_{SS} \text{ or } V_{DD}$	10 V	-	10	-	10	-	300	-	300	μΑ
			15 V	-	20	-	20	-	600	-	600	μΑ
Cı	input capacitance		-	-	-	-	7.5	-	-	-	-	pF

Table 6. Static characteristics ...continued

 $V_{\rm SS} = 0$ V; $V_{\rm I} = V_{\rm SS}$ or $V_{\rm DD}$ unless otherwise specified.

10. Dynamic characteristics

Table 7. Dynamic characteristics

$T_{amb} = 25 \ ^{\circ}C; V_{SS} = 0 \ V;$ for test circuit see Figure 10

Symbol	Parameter	Conditions	V _{DD}	Extrapolation formula ^[1]	Min	Тур	Max	Unit
t _{PHL}		CP0, $\overline{CP}1 \rightarrow Q0$ to Q9;	5 V	113 ns + (0.55 ns/pF)C _L	-	140	280	ns
	propagation delay	see <u>Figure 7</u>	10 V	44 ns + (0.23 ns/pF)C _L	-	55	110	ns
			15 V	32 ns + (0.16 ns/pF)C _L	-	40	80	ns
		CP0, $\overline{CP1} \rightarrow \overline{Q5-9}$; see <u>Figure 7</u>	5 V	118 ns + (0.55 ns/pF)C _L	-	145	290	ns
			10 V	44 ns + (0.23 ns/pF)C _L	-	55	110	ns
			15 V	32 ns + (0.16 ns/pF)C _L	-	40	80	ns
		MR \rightarrow Q1 to Q9;	5 V	88 ns + (0.55 ns/pF)C _L	-	115	230	ns
			10 V	39 ns + (0.23 ns/pF)C _L	-	50	100	ns
			15 V	27 ns + (0.16 ns/pF)C _L	-	35	70	ns

Dynamic characteristics ... continued

Table 7.

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Symbol	Parameter	Conditions	V_{DD}	Extrapolation formula ^[1]	Min	Тур	Max	Unit
t _{PLH}	LOW to HIGH	CP0, $\overline{CP}1 \rightarrow Q0$ to Q9;	5 V	98 ns + (0.55 ns/pF)C _L	-	125	250	ns
	propagation delay	see Figure 7	10 V	39 ns + (0.23 ns/pF)C _L	-	50	100	ns
			15 V	32 ns + (0.16 ns/pF)C _L	-	40	80	ns
		CP0, $\overline{CP}1 \rightarrow \overline{Q}5-9$;	5 V	98 ns + (0.55 ns/pF)C _L	-	125	250	ns
		see Figure 7	10 V	39 ns + (0.23 ns/pF)C _L	-	50	100	ns
			15 V	32 ns + (0.16 ns/pF)C _L	-	40	80	ns
		$MR \rightarrow \overline{Q}5-9;$	5 V	83 ns + (0.55 ns/pF)C _L	-	110	220	ns
		see Figure 8	10 V	34 ns + (0.23 ns/pF)C _L	-	45	90	ns
			15 V	27 ns + (0.16 ns/pF)C _L	-	35	70	ns
		$MR \rightarrow Q0;$	5 V	103 ns + (0.55 ns/pF)C _L	-	130	260	ns
		see Figure 8	10 V	44 ns + (0.23 ns/pF)C _L	-	55	105	ns
			15 V	32 ns + (0.16 ns/pF)C _L	-	40	75	ns
t _t transiti	transition time	see Figure 7	5 V	2 10 ns + (1.00 ns/pF)C _L	-	60	120	ns
			10 V	9 ns + (0.42 ns/pF)C _L	-	30	60	ns
			15 V	6 ns + (0.28 ns/pF)C _L	-	20	40	ns
t _h	hold time	$CP0 \rightarrow \overline{CP}1;$	5 V		90	45	-	ns
		see <u>Figure 9</u>	10 V		40	20	-	ns
			15 V		20	10	-	ns
		$\overline{CP}1 \rightarrow CP0;$ see <u>Figure 9</u>	5 V		80	40	-	ns
			10 V		40	20	-	ns
			15 V		30	10	-	ns
t _W	pulse width	CP0 input LOW;	5 V		80	40	-	ns
		minimum width; see Figure 8	10 V		40	20	-	ns
			15 V		30	15	-	ns
		CP1 input HIGH;	5 V		80	40	-	ns
		minimum width; see Figure 8	10 V		40	20	-	ns
			15 V		30	15	-	ns
		MR input HIGH;	5 V		50	25	-	ns
		minimum width; see Figure 8	10 V		30	15	-	ns
			15 V		20	10	-	ns
rec	recovery time	MR input;	5 V		60	30	-	ns
		see Figure 8	10 V		30	15	-	ns
			15 V		20	10	-	ns
max	maximum	see Figure 8	5 V		6	12	-	MHz
	frequency		10 V		12	30	-	MHz
			15 V		15	30	-	MHz

[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C_L in pF).

[2] t_t is the same as t_{THL} and t_{TLH} .

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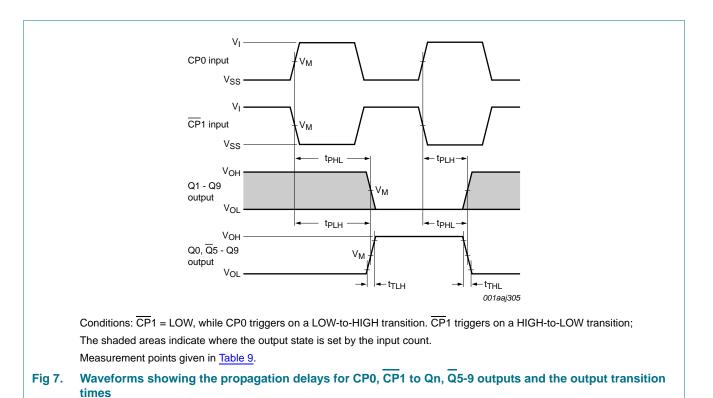
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P _D can be	P_D can be calculated from the formulas shown. $V_{SS} = 0$ V; $t_r = t_f \le 20$ ns; $T_{amb} = 25$ °C.										
Symbol	Parameter	V_{DD}	Typical formula for P_D (μ W)	where:							
P _D	dynamic power dissipation	5 V	$P_D = 500 \times f_i + \Sigma(f_o \times C_L) \times V_DD^2$	f _i = input frequency in MHz;							
		10 V	$P_D = 2200 \times f_i + \Sigma (f_o \times C_L) \times V_DD^2$	$f_o = output frequency in MHz;$							
		15 V	$P_D = 6000 \times f_i + \Sigma (f_o \times C_L) \times V_DD^2$	C_L = output load capacitance in pF;							
				V _{DD} = supply voltage in V;							
				$\Sigma(C_L \times f_o)$ = sum of the outputs.							

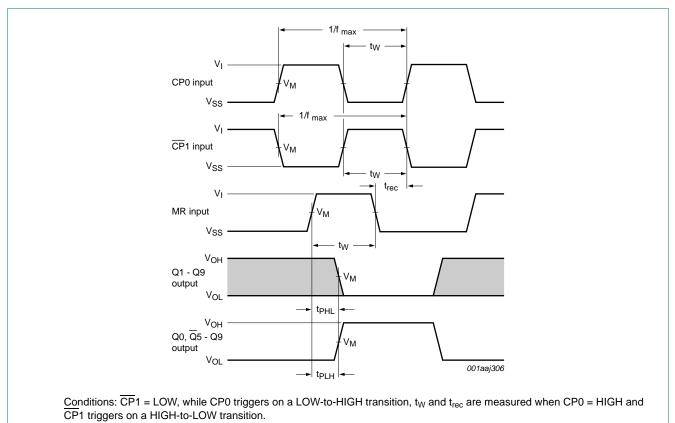
Table 8. Dynamic power dissipation P_D

11. Waveforms



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The shaded areas indicate where the output state is set by the input count.

Measurement points given in Table 9.

Fig 8. Waveforms showing the minimum pulse width for CP0, CP1 and MR input; the maximum frequency for CP0 and CP1 input; the recovery time for MR and the MR input to Qn and Q5-9 output propagation delays

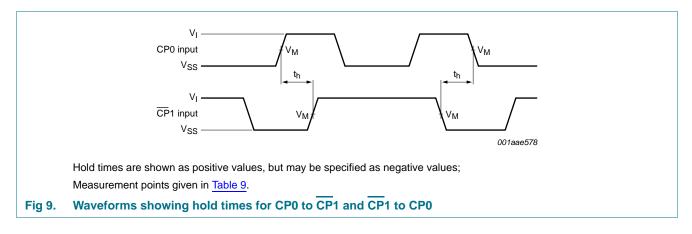
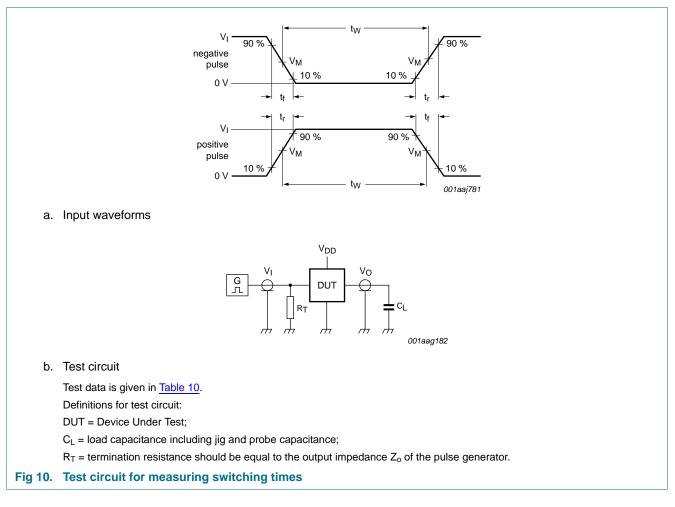


Table 9. Measurement points

Supply voltage	Input	Output
V _{DD}	V _M	V _M
5 V to 15 V	0.5V _{DD}	0.5V _{DD}

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	Tab	le 1	0.	Test	data
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Supply voltage	Input		Load
V _{DD}	VI	t _r , t _f	CL
5 V to 15 V	V _{SS} or V _{DD}	\leq 20 ns	50 pF

12. Application information

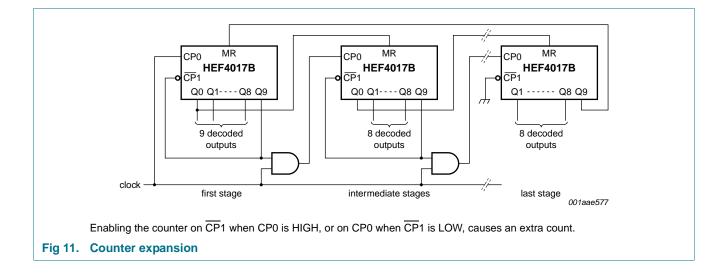
Some examples of applications for the HEF4017B are:

- · Decade counter with decimal decoding
- 1 out of n decoding counter (when cascaded)
- Sequential controller
- Timer

Figure 11 shows a technique for extending the number of decoded output states for the HEF4017B. Decoded outputs are sequential within each stage and from stage to stage, with no dead time (except propagation delay).

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13. Package outline

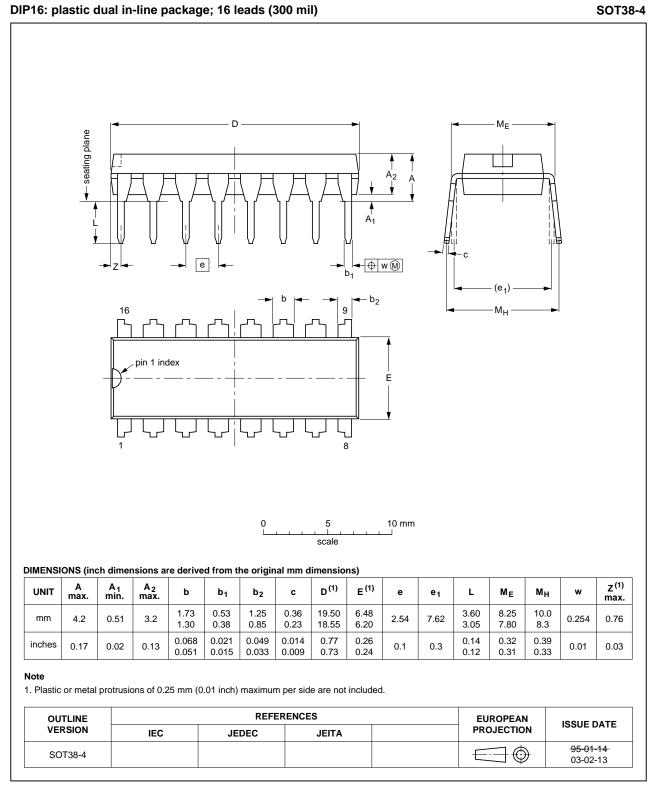


Fig 12. Package outline SOT38-4 (DIP16)

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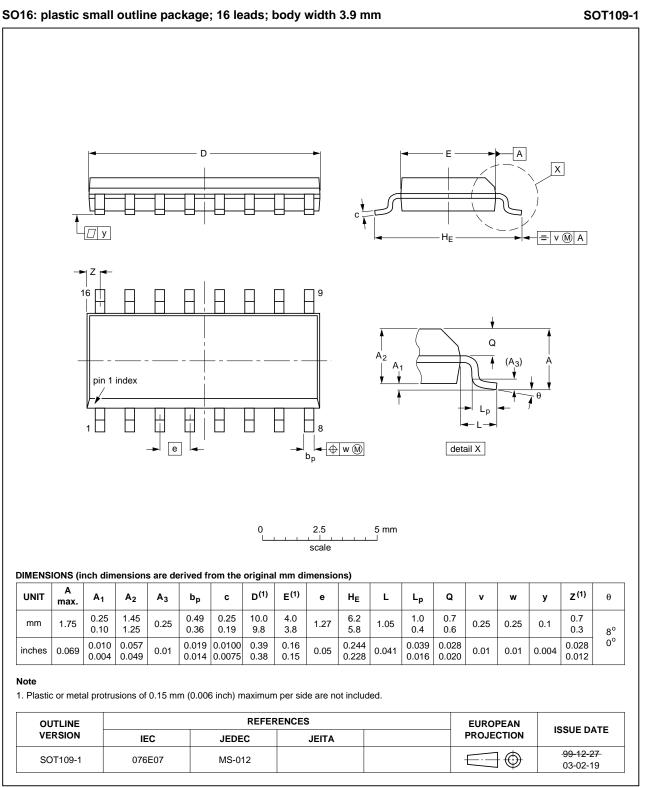


Fig 13. Package outline SOT109-1 (SO16)

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HEF4017B

14. Revision history

Table 11. Revision his	story			
Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4017B v.8	20111118	Product data sheet	-	HEF4017B v.7
Modifications:	 Legal pages 	s updated.		
	 Changes in 	"General description" and "	Features and benefits".	
	 Section "Ap 	plications" removed.		
HEF4017B v.7	20110914	Product data sheet	-	HEF4017B v.6
HEF4017B v.6	20091105	Product data sheet	-	HEF4017B v.5
HEF4017B v.5	20090709	Product data sheet	-	HEF4017B v.4
HEF4017B v.4	20081209	Product data sheet	-	HEF4017B_CNV v.3
HEF4017B_CNV v.3	19950101	Product specification	-	HEF4017B_CNV v.2
HEF4017B_CNV v.2	19950101	Product specification	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Date of release: 18 November 2011 Document identifier: HEF4017B